

Bridge Rectifiers

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

| Symbol | Parameter | Value | | | | | | Units | |
|--------------------|---|-------------|-----|-----|---------|-----|-----|-------|----|
| | | 6A | 6B | 6D | 6G | 6J | 6K | 6M | |
| V _{RRM} | Maximum Repetitive Reverse Voltage | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| V _{RMS} | Maximum RMS Bridge Input Voltage | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| V _R | DC Reverse Voltage (Rated V _R) | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| I _{F(AV)} | Average Rectified Forward Current, @ $T_A = 100^{\circ}C$ | 6.0 | | | | А | | | |
| I _{FSM} | Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave | 175 | | | | А | | | |
| T _{stg} | Storage Temperature Range | -55 to +150 | | | °C | | | | |
| TJ | Operating Junction Temperature | | | -5 | 55 to + | 150 | | | °C |

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

| Symbol | Parameter | Value | Units |
|------------------------|---|-------|-------|
| P _D | Power Dissipation | 12 | W |
| $R_{	ext{	hetaJA}}$ | Thermal Resistance, Junction to Ambient,* per leg | 18.6 | °C/W |
| $R_{_{	ext{	hetaJL}}}$ | Thermal Resistance, Junction to Lead,** per leg | 3.1 | °C/W |

*Device mounted on PCB with 0.5 x 0.5" (12 x 12 mm).

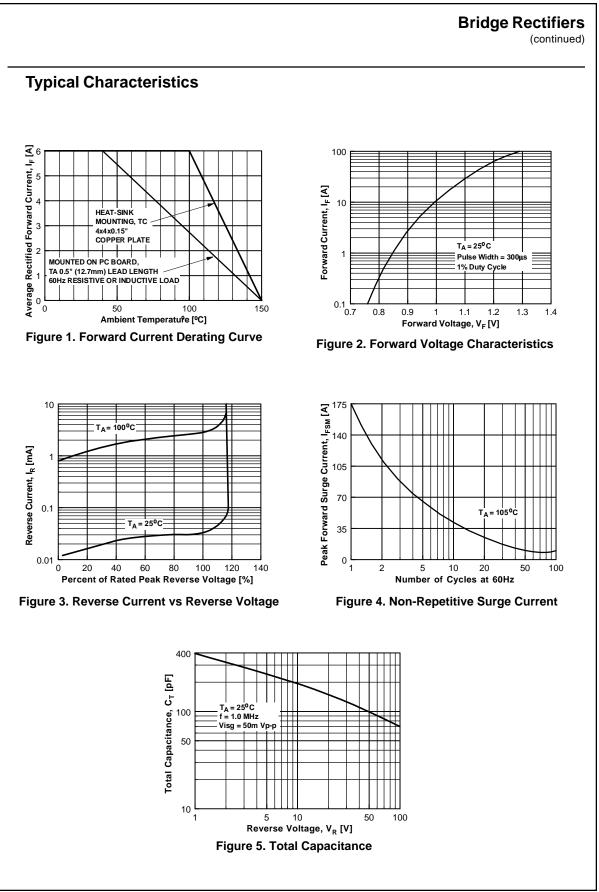
** Device mounted on Al plate with 2.6 x 1.4" x 0.06" (6,5 x 3.5 x 0.15 cm).

Electrical Characteristics T_A = 25°C unless otherwise noted

| Symbol | Parameter | Device | Units |
|----------------|---|------------|------------------|
| V _F | Forward Voltage, per element @ 6.0 A | 1.0 | V |
| I _R | Reverse Current, per element @ rated V_R $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$ | 5.0 500 | μΑ μΑ |
| | l^2 t rating for fusing t < 8.35 ms | 127 | A ² s |

©2001 Fairchild Semiconductor Corporation

GBU6A-GBU6M, Rev. C



©2001 Fairchild Semiconductor Corporation

GBU6A-GBU6M, Rev. C

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACExTM BottomlessTM CoolFETTM CROSSVOLTTM DenseTrenchTM DOMETM EcoSPARKTM E²CMOSTM EnSignaTM FACTTM FACT Quiet SeriesTM FAST $^{\textcircled{(0)}}$ OPTOLFASTrTMOPTOFFRFETTMPACMAGlobalOptoisolatorTMPOPTMGTOTMPower2HiSeCTMPower7ISOPLANARTMQFETTMLittleFETTMQSTMMicroFETTMQT OptMicroPakTMQuiet SMICROWIRETMSILENT

OPTOLOGIC[™] OPTOPLANAR[™] PACMAN[™] POP[™] Power247[™] PowerTrench[®] QFET[™] QS[™] QT Optoelectronics[™] Quiet Series[™] SILENT SWITCHER[®] SMART START[™] VCX[™] STAR*POWER[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET[™] TinyLogic[™] TruTranslation[™] UHC[™] UltraFET[®]

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Product Status | Definition |
|---------------------------|---|
| Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |
| | Formative or In Design First Production Full Production |